

Description

Passivated, sensitive gate triacs in a plastic envelope, intended for use in general purpose bidirectional switching and phase control applications, where high sensitivity is required in all four quadrants.

Symbol 		Simplified outline  TO-220	
Pin	Description		
1	Main terminal 1 (T1)		
2	Main terminal 2 (T2)		
3	gate (G)		
TAB	Main terminal 2 (T2)		

Applications:

- ◆ Motor control
- ◆ Industrial and domestic lighting
- ◆ Heating
- ◆ Static switching

Features

- ◆ Blocking voltage to 600 V
- ◆ On-state RMS current to 12 A

SYMBOL	PARAMETER	Value	Unit
V_{DRM}	Repetitive peak off-state voltages	600	V
$I_T (RMS)$	RMS on-state current	12	A
I_{TSM}	Non-repetitive peak on-state current	95	A

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
$R_{th j-mb}$	Thermal resistance Junction to mounting base	Full cycle	-	-	1.5	K/W
		Half cycle	-	-	2.0	K/W
$R_{th j-a}$	Thermal resistance Junction to ambient	In free air	-	60	-	K/W

Limiting values in accordance with the Maximum system(IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN	Value	UNIT
V_{DRM}	Repetitive peak off-state Voltages		-	600	V
$I_{T(RMS)}$	RMS on-state current	Full sine wave; $T_{mb} \leq 99^{\circ}C$	-	12	A
I_{TSM}	Non-repetitive surge peak on-state current	full sine wave;, $T_J=25^{\circ}C$ prior to surge	$t=20ms$	95	A
			$t=16.7ms$	105	A
I^2t	I^2t for fusing	$T=10ms$	-	45	A^2S
di_T/dt	Repetitive rate of rise of on-state current after triggering	$I_{TM}=20A; I_G=0.2A;$ $DI_G/dt=0.2A/\mu s$			
			T2+G+	50	A/ μs
			T2+G-	50	A/ μs
			T2-G-	50	A/ μs
			T2-G+	10	A/ μs
I_{GM}	Peak gate current		-	2	A
V_{GM}	Peak gate voltage		-	5	V
P_{GM}	Peak gate power		-	5	W
$P_{G(AV)}$	Average gate power	Over any 20 ms period	-	0.5	W
T_{stg}	Storage temperature		-40	150	$^{\circ}C$
T_J	Operating junction Temperature		-	125	$^{\circ}C$

$T_J=25^{\circ}C$ unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
Static characteristics						
I_{GT1}	Gate trigger current	$V_D=12V; I_T=0.1A$				
			T2+G+	1.3	5	mA
			T2+G-	2.8	5	mA
			T2-G-	3.2	5	mA
			T2-G+	5.5	10	mA
I_L	Latching current	$V_D=12V; I_{GT}=0.1A$				
			T2+G+	-	15	mA
			T2+G-	-	20	mA
			T2-G-	-	15	mA
			T2-G+	-	20	mA
I_H	Holding current	$V_D=12V; I_{GT}=0.1A$	-	-	10	mA
V_T	On-state voltage	$I_T=15A$	-	1.4	1.65	V
V_{GT}	Gate trigger voltage	$V_D=12V; I_T=0.1A$	-	0.7	1.5	V
		$V_D=V_{DRM}; I_T=0.1A; T_J=125^{\circ}C$	0.25	0.4	-	V
I_D	Off-state leakage current	$V_D=V_{DRM(max)}; T_J=125^{\circ}C$	-	0.1	0.5	mA

Dynamic Characteristics

dV_D/dt	Critical rate of rise of Off-state voltage	$V_{DM}=67\% V_{DRM(max)}; T_J=110^{\circ}C;$ Exponential wave form; gate open circuit	-	50	-	V/ μs
t_{gt}	Gate controlled turn-on time	$I_{TM}=16A; V_D=V_{DRM(max)}; I_G=0.1A;$ $DI_G/dt=5A/\mu s$	-	2	-	μs

Description

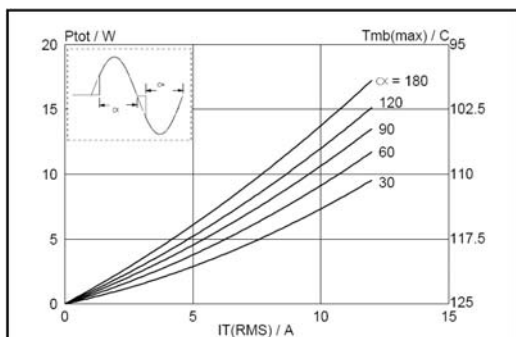


Fig.1. Maximum on-state dissipation, P_{tot} , versus rms on-state current, $I_{T(RMS)}$, where α = conduction angle.

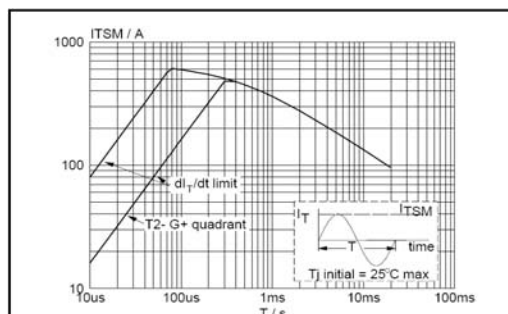


Fig.2. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus pulse width t_p , for sinusoidal currents, $t_p \leq 20$ ms.

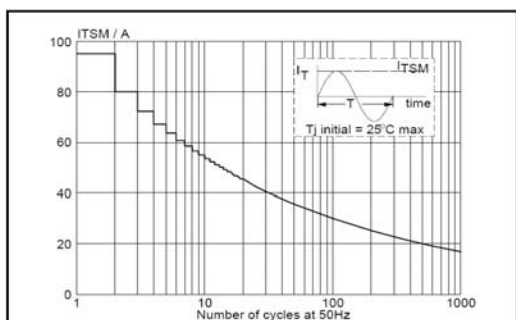


Fig.3. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus number of cycles, for sinusoidal currents, $f = 50$ Hz.

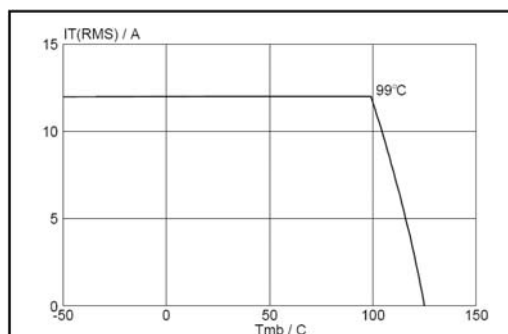


Fig.4. Maximum permissible rms current $I_{T(RMS)}$, versus mounting base temperature T_{mb} .

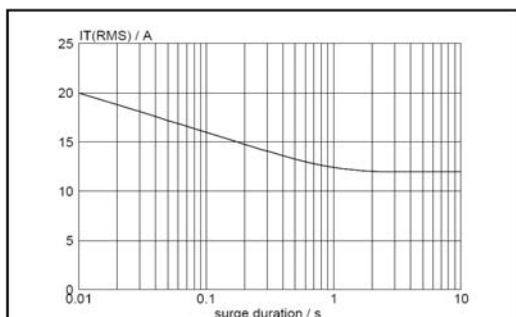


Fig.5. Maximum permissible repetitive rms on-state current $I_{T(RMS)}$, versus surge duration, for sinusoidal currents, $f = 50$ Hz; $T_{mb} \leq 99^\circ\text{C}$.

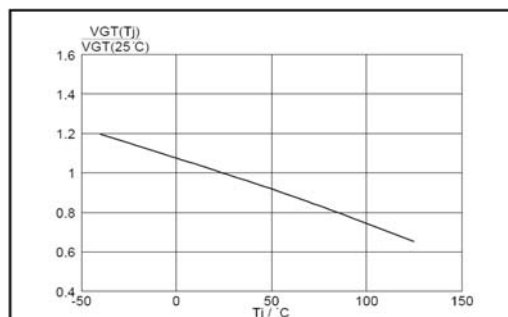
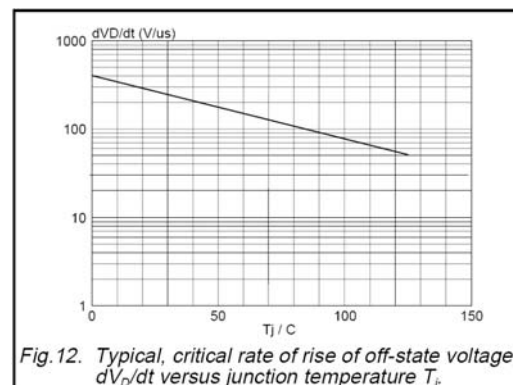
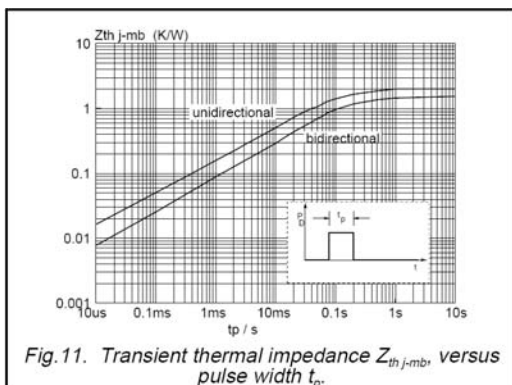
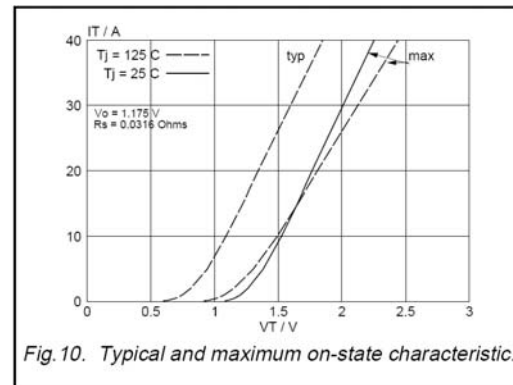
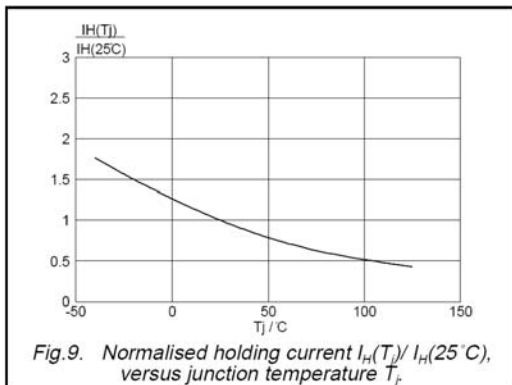
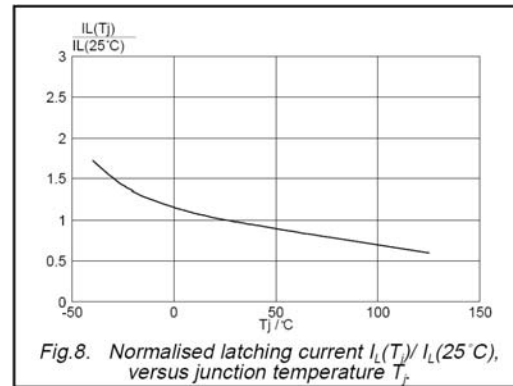
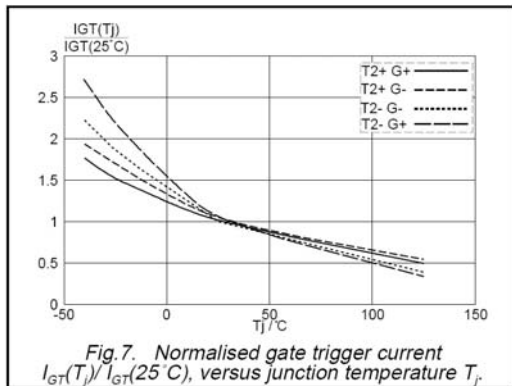


Fig.6. Normalised gate trigger voltage $V_{GT}(T_j)/V_{GT}(25^\circ\text{C})$, versus junction temperature T_j .

Description



MECHANICAL DATA

Dimensions in mm
Net Mass: 2 g

